

0057-2608-2YY



IN THE UNITED STATES PATENT & TRADEMARK OFFICE

IN RE APPLICATION OF

Toshiaki SHINOHARA, et al.

: EXAMINER: CHU, Chris C.

SERIAL NO: 09/534,043

FILED: March 24, 2000

: GROUP ART UNIT: 2815

FOR: SEMICONDUCTOR MODULE
AND INSULATING SUBSTRATE
THEREFOR

6/26/2
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RECEIVED
TECHNOLOGY CENTER 2800

AMENDMENT

ASSISTANT COMMISSIONER FOR PATENTS
WASHINGTON, D.C. 20231

SIR:

In response to the Official Action dated April 8, 2002, please amend the above-identified application as follows:

IN THE SPECIFICATION

Page 7, line 4, please insert the following paragraph:

Fig. 2A is a cross-sectional view of the semiconductor module shown as mounted on the external heat sink according to a preferred embodiment of the present invention;

Page 7, after line 6, please insert the following paragraph: